#### TOSHIBA Schottky Barrier Rectifier Schottky Barrier Type

**TENTATIVE** 

**CUS02** 

Swithing mode power supply applications Portable equipment battery application

Forward Voltage

: V<sub>FM</sub>=0.45V(max)

Average Forward Current

: I<sub>F(AV)</sub>=0.7A

Repetitive Peak Reverse Voltage : V<sub>RRM</sub>=30V

Small & Thin package " US-FLAT<sup>TM</sup> "(Toshiba package name)

Maximum Ratings(Ta=25°C)

maximum realings (ra 200)			
Characteristics	Symbol	Rating	Unit
Repetitive Peak Reverse Voltage	$V_{RRM}$	30	٧
Average Forward Current	I <sub>F(AV)</sub>	0.7	Α
Peak one Cycle Surge Forward Current	I <sub>FSM</sub>	20(50Hz)	Α
Junction Temperature	Tj	-40 ~ 150	°C
Storage Temperature Range	T <sub>stg</sub>	-40 ~ 150	°C

Note: Ta=77°C:On glass-epoxy substrate

substrate size:50mm×50mm

land size:6mm×6mm

Rectangular waveform(α=180°), VR=15V

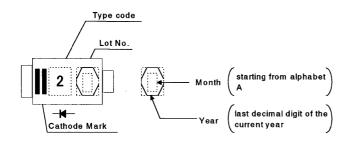
Unit in mm 2.5±0.2 1.ANODE 2.CATHODE **JEDEC** JEITA TOSHIBA Weight: 0.004g

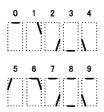
Flectrical Characteristics (Ta=25°C)

Electrical Characteristics (1a=25 C						
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Peak Forward Voltage	V <sub>FM(1)</sub>	I <sub>FM</sub> =0.1A	-	0.35	-	V
	$V_{FM(2)}$	I <sub>FM</sub> =0.3A	-	0.38	-	
	V <sub>FM(3)</sub>	I <sub>FM</sub> =0.7A	-	0.42	0.45	
Repetitive Peak Reverse Current	I <sub>RRM(1)</sub>	V <sub>RRM</sub> =5V	-	0.7	-	μА
	I <sub>RRM(2)</sub>	V <sub>RRM</sub> =30V	-	10	100	
Junction Capacitance	Cj	VR=10V,f=1.0MHz	-	40	-	рF
Thermal Resistance	Rth(j-a)	On ceramic substrate (Solderring Land 2mm×2mm)	-	-	75	°C/W
		On glass-epoxy substrate (Solderring Land 6mm×6mm)	-	-	150	
	Rth(j-l)	Junction to read of cathode sid	-	-	30	

# Marking

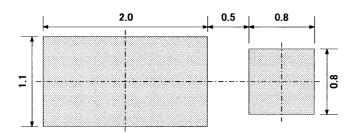
# Following Indicates the Data of Manufacture





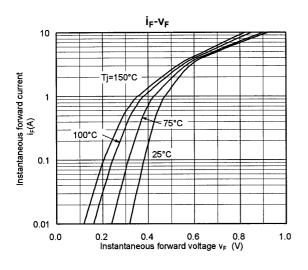
## Standard Soldering Pad

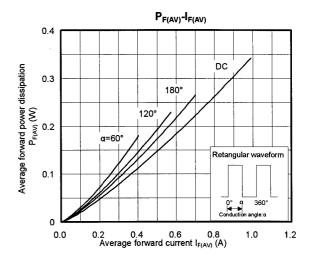
#### Unit in mm

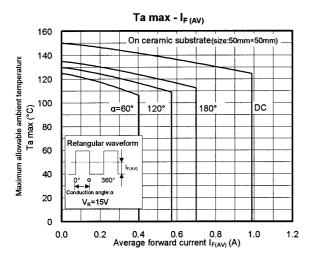


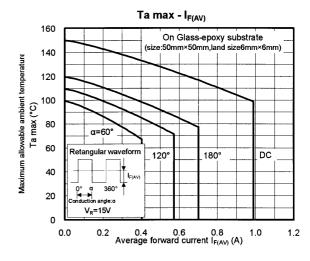
### **Handling Precaution**

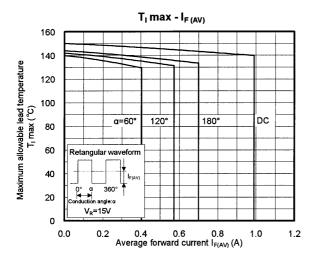
Schottky barrier diodes are having large-reverse-current-leakage characteristic compare to the other rectifier products. This current leakage and not proper operating temperature or voltage may cause thermal runaway. Please take forward and reverse loss into consideration when you design.

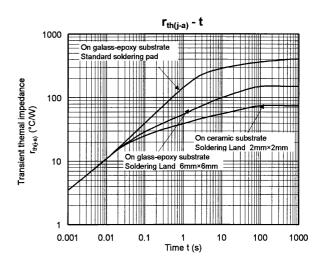


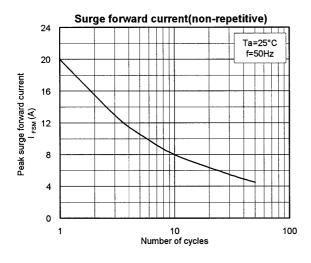


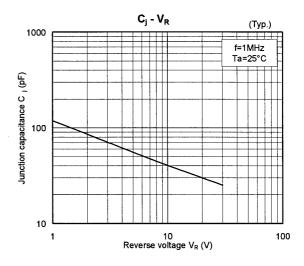


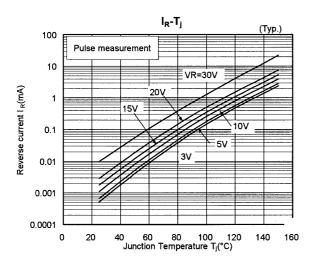


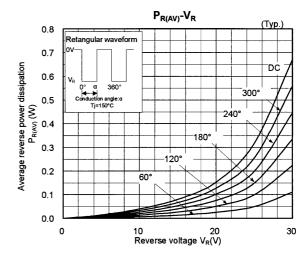












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